



# **InGaAs linear image sensors**

G9201 to G9204 series

# **Image sensor for DWDM wavelength monitor**

The G9201 to G9204 series are InGaAs linear image sensors designed for WDM monitor detectors in optical communications. These linear image sensors contain a CMOS charge amplifier array, a CDS circuit, an offset compensation circuit, a shift register and a timing generator, along with an InGaAs photodiode array, and deliver high sensitivity and stable operation in the near infrared range. The package is hermetically sealed for high reliability and the light input window has an anti-reflective coating to improve the light detection efficiency.

The signal processing circuit on the CMOS chip allows selecting two conversion efficiencies (CE) by external voltage. A wide dynamic range can be obtained when the image sensor is operated at CE=16 nV/e<sup>-</sup>, while a high gain can be obtained at CE=320 nV/e⁻.

#### Features

- Wide dynamic range
- Low noise and low dark current
- Two selectable conversion efficiencies
- Anti-saturation circuit
- **CDS circuit\*1**
- Offset compensation circuit
- Simple operation (by built-in timing generator \*2)
- High resolution: 25 μm pitch (512 ch)
- **■** Low crosstalk
- **≥** 256 ch: 1 video line 512 ch: 2 video lines

### Applications

- DWDM wavelength monitor
- Optical spectrum analyzer

#### Options

- → InGaAs multichannel detector head C8061-01\*3
- Multichannel detector head controller C7557-01\*3

- \*1: A major source of noise in charge amplifiers is the reset noise generated when the integration capacitance is reset. A CDS circuit greatly reduces this reset noise by holding the signal immediately after reset to find the noise differential.
- In conventional image sensor operation, external PLD (programmable logic device), etc. is used to input the required timing signals. However, the G9201 to G9204 series image sensors internally generate all timing signals on the CMOS chip just by supplying CLK and RESET pulses. This makes it simple to set the timings.
- \*3: The G9203-256D and G9204-512D are not available for the C7557-01.

#### Selection guide

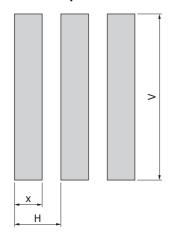
Type no.	Cooling	Image size (mm)	Number of total pixels	Number of effective pixels	Spectral response range (µm)	Defective pixels	Appilcable multichannel detector head
G9201-256S	One-stage TE-cooled	12.8 × 0.25	256	256	0.9 to 1.67 (-10 °C)		C8061-01
G9202-512S	One-stage TE-cooled	12.0 ^ 0.23	512	512	0.9 to 1.67 (-10 °C)		C8061-01
G9203-256D*4	Non-cooled		256	256	0.9 to 1.7 (25 °C)	_	-
G9203-256S	One-stage TE-cooled	12.8 × 0.50	256	256	0.9 to 1.67 (-10 °C)		C8061-01
G9204-512D*4	Non-cooled	12.6 * 0.30	512	512	0.9 to 1.7 (25 °C)		-
G9204-512S	One-stage TE-cooled		512	512	0.9 to 1.67 (-10 °C)		C8061-01

#### **Structure**

Type no.	Pixel size [µm (H) × µm (V)]	Pixel pitch (µm)	Package	Window material
G9201-256S	50 × 250	50	28-pin metal	Sapphire glass with
G9202-512S	25 × 250	25	(refer to the dimensional outline)	anti-reflective coating
G9203-256D*4	50 × 500	50	22-pin ceramic	Borosilicate glass with anti-reflective coating
G9203-256S	30 ^ 300	50	28-pin metal (refer to the dimensional outline)	Sapphire glass with anti-reflective coating
G9204-512D* <sup>4</sup>	25 × 500	25	22-pin ceramic	Borosilicate glass with anti-reflective coating
G9204-512S		25	28-pin metal (refer to the dimensional outline)	Sapphire glass with anti-reflective coating

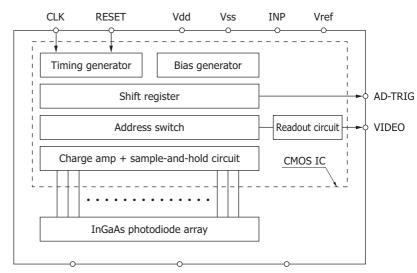
<sup>\*4:</sup> For the G9203-256D and G9204-512D specifications, see the separate datasheet available from HAMAMATSU.

#### Details of photosensitive area (unit: mm)



Number of pixels	Х	Н	V
256	30	50	250
230	30	50	500
512	10	25	250
512	10	25	500

**Block diagram** 



Thermoelectric cooler + Thermoelectric cooler - Temperature monitor

KMIRC0033EA

#### **■** Absolute maximum ratings

Parameter	Symbol	Condition	Min.	Max.	Unit
Operating temperature	Topr	Chip and package temperature, No dew condensation*5	-40	+70	°C
Storage temperature	Tstg	Chip and package temperature, No dew condensation*5	-40	+85	°C
Supply voltage	Vdd, INP, Vref	Ta=25 °C	-0.3	+6	V
Clock pulse voltage	Vφ	Ta=25 °C	-0.3	+6	V
Reset pulse voltage	V(RES)	Ta=25 °C	-0.3	+6	V
Gain selection terminal voltage	Vcsel	Ta=25 °C	-0.3	+6	V

<sup>\*5:</sup> When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.



Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

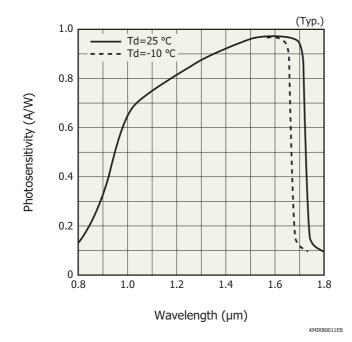
# **⇒** Recommended terminal voltage

Parameter	Parameter		Min.	Тур.	Max.	Unit
Supply voltage		Vdd	4.9	5.0	5.1	V
		Vref	-	1.26	-	V
Element bias		INP	3.5	4.5	4.6	V
Ground		Vss	-	0	-	V
Clask pulsa valtaga	High	Vφ	Vdd - 0.5	Vdd	Vdd + 0.5	W
Clock pulse voltage	Low	- νφ	0	0	0.4	٧
Decet mules valteres	High	\//DEC\	Vdd - 0.5	Vdd	Vdd + 0.5	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Reset pulse voltage	Low	V(RES)	0	0	0.4	] <b>v</b>

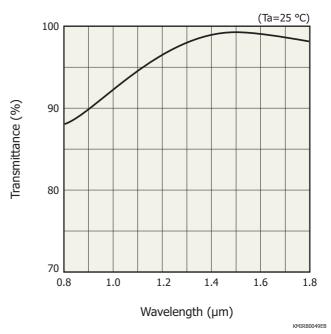
# **■** Electrical characteristics (Ta=25 °C)

Parameter		Symbol		Min.	Тур.	Max.	Unit
		1(//44)	256 pixels	-	45	50	mA
Concumption current		I(Vdd)	512 pixels	-	90	100	IIIA
Consumption current		I(	Vref)	-	-	1	mA
		I(INP)		-	-	1	mA
Clock frequency		f		0.1	-	4	MHz
Video data rate	Video data rate		fV	0.0125	f/8	0.5	MHz
Video output voltage	High		VH	-	4.5	INP	V
Video output voltage	Low		VL	Vref	1.26	-	V
Output offset voltage		Vos		-	Vref	-	V
A/D trigger voltage	High	V	trigн	-	Vdd	-	V
AD trigger voltage	Low	V	ˈtrigL	-	GND	-	V

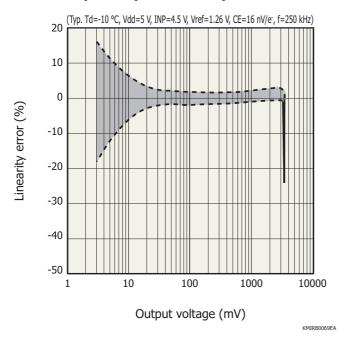
# - Spectral response



# Spectral transmittance characteristic of window material (typical example)



# **Linearity error (G9203-256S)**



# **■** Electrical and optical characteristics (Td=25 °C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Peak sensitivity wavelength	λр		-	1.55	-	μm
Photosensitivity	S	$\lambda = \lambda p$	0.85	0.95	-	A/W
Conversion efficiency	CE	Cf=10pF	-	16	-	nV/e⁻
Saturation voltage	Vsat		3.0	3.2	-	V
Saturation charge	Qsat	*6	30	32	-	рC
Photoresponse nonuniformity	PRNU	*7	-	±2	±5	%
RMS noise voltage (readout noise)	N	Standard deviation, Integration count=50	-	180	300	μV rms
Dynamic range	D	*6	10000	17777	-	-
Defective pixels*8	-		-	-	0	%

<sup>\*6:</sup> V $\phi$ =5 V, CE=16 nV/e<sup>-</sup>

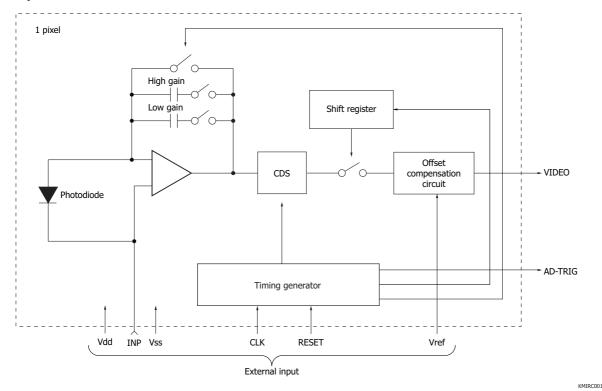
# **■** Dark output characteristics (Td=25 °C, CE=16 nV/e<sup>-</sup>)

Parameter		Symbol	Min.	Typ.	Max.	Unit
	G9201-256S		-1	0.2	1	V/s
Dark output (dark output nonuniformity)	G9202-512S	Vo	-0.5	0.1	0.5	
	G9203-256S	VD	-2	0.4	2	
	G9204-512S		-0.5	0.1	0.5	
Dark current	G9201-256S		-10	2	10	
	G9202-512S	To	-5	1	5	n A
	G9203-256S	ID	-20	4	20	pA
	G9204-512S		-5	1	5	

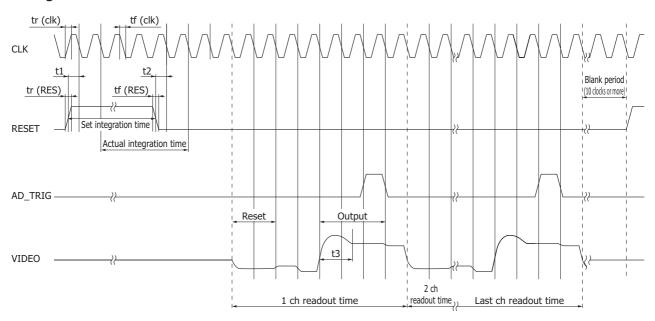
<sup>\*7: 50 %</sup> of saturation, integration time=10 ms, after dark output subtraction, excluding first and last pixels

<sup>\*8:</sup> Pixels with photoresponse nonuniformity, readout noise or dark current higher than the maximum value

# **Equivalent circuit**



# **Timing chart**

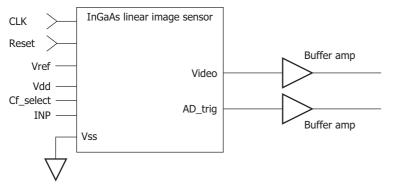


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Parameter	Symbol	Min.	Тур.	Max.	Unit
Clock pulse frequency	-	0.1	-	4	MHz
Clock pulse width	tpw (clk)	100	-	-	ns
Clock pulse rise/fall times	tr (clk), tf (clk)	0	20	100	ns
Reset pulse width	tpw (RES)	6000	-	-	ns
Reset pulse rise/fall times	tr (RES), tf (RES)	0	20	100	ns
Reset (rise) timing	t1	50	-	-	ns
Reset (fall) timing	t2	50	-	-	ns
Output settling time	t3	-	-	600	ns

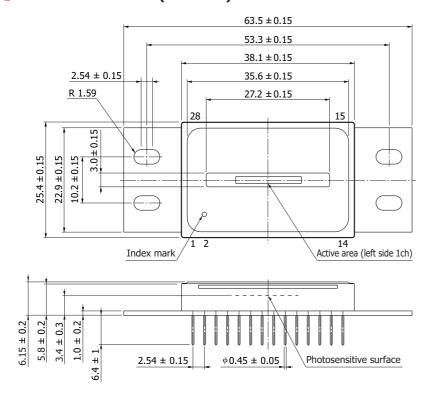


#### **Basic circuit connection**



KMIRC0012EA

# - Dimensional outline (unit: mm)





Center accuracy of active area:

±0.3 mm or less (with package center as reference point)

Rotation accuracy of active area:

±2° or less (with package center as reference point)

Chip material: InGaAs Package material: FeNi alloy Lead treatment: Ni/Au plating Lead material: FeNiCo alloy Window material: sapphire

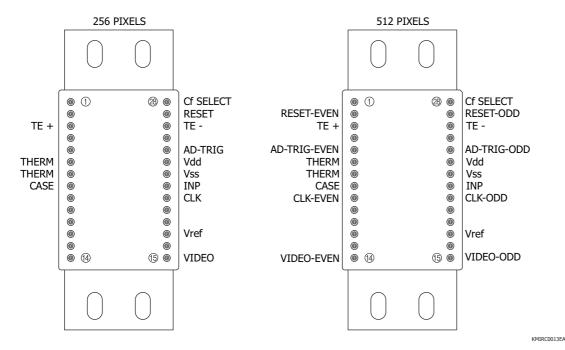
Refractive index of window material: n=1.76 Window material thickness: 0.66 mm AR coat: coated (1.55 µm peak)

AR coat: coated (1.55 µm peak) Window sealing method: brazing

Cap sealing: welding

KMIRA0010EC

#### Pin connections (top view)



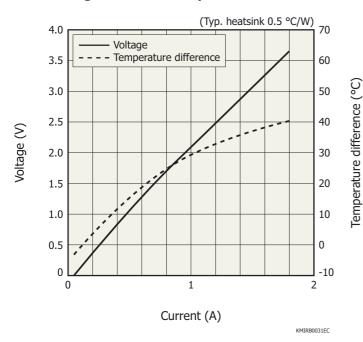
Terminal name Input/Output Function and recommended connection Input (CMOS logic compatible) Clock pulse for operating the CMOS shift register CLK Reset pulse for initializing the feedback capacitance in the charge amplifier formed **RESET** Input (CMOS logic compatible) on the CMOS chip. The width of the reset pulse is integration time. Vdd Supply voltage for operating the signal processing circuit on the CMOS chip Input Ground for the signal processing circuit on the CMOS chip Vss INP Input Reset voltage for the charge amplifier array on the CMOS chip Voltage that determines the feedback capacitance (Cf) on the CMOS chip. Cf SELECT Input Low gain (CE=16 nV/e<sup>-</sup>) at 0 V, and high gain (CE=320 nV/e<sup>-</sup>) at 5 V. CASE This terminal is electrically connected to the package. THERM Thermistor terminal for monitoring temperature inside the package Output Power supply terminal for the thermoelectric cooler that cools the photodiode array TE+, TE Input **AD-TRIG** Digital signal for A/D conversion; positive polarity Output VIDEO Analog video signal; positive polarity Output Vref Reset voltage for the offset compensation circuit on the CMOS chip Input

#### **■** Specifications of one-stage TE-cooler (Ta=25 °C, Vdd=5 V, INP=4.5 V)

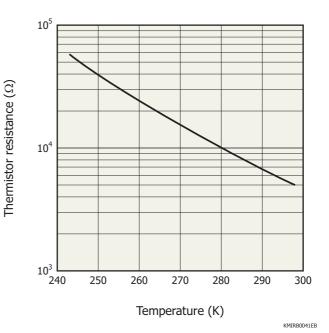
Parameter	Condition	Symbol	Min.	Тур.	Max.	Unit
TE-cooler allowable current		Ic Max.	-	-	1.8	Α
TE-cooler allowable voltage		Vc Max.	-	-	5.0	V
Temperature difference *8	Ic=1.4 A	Δt	40	-	-	°C
Thermistor resistance		Rth	4.85	5.00	5.15	kΩ
Thermistor power dissipation		Pth	-	-	0.2	mW

<sup>\*8:</sup> This is a temperature difference between the surface of active area and the heat radiating portion of package.

# **►** One-stage TE-cooler temperature characteristic



#### **Thermistor temperature characteristic**



A relation between the thermistor resistance and absolute temperature is expressed by the following equation.

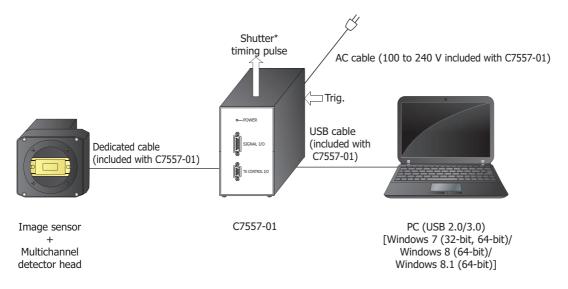
 $R1=R2 \times exp B (1/T1 - 1/T2)$ 

R1: Resistance at T1 [K] R2: Resistance at T2 [K]

B: B constant (B=3200 K  $\pm$  2%)

Thermistor resistance =  $5 \text{ k}\Omega \pm 3\%$  (298 K)

#### Connection of related products



<sup>\*</sup> Shutter, etc. are not available.

KACCC0402ED

#### **Electrostatic countermeasures**

This device has a built-in protection circuit against static electrical charges. However, to prevent destroying the device with electrostatic charges, take countermeasures such as grounding yourself, the workbench and tools to prevent static discharges. Also protect this device from surge voltages which might be caused by peripheral equipment.

### - Related information

www.hamamatsu.com/sp/ssd/doc\_en.html

- Precautions
- Disclaimer
- · Image sensors

Information described in this material is current as of July, 2015.

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# HAMAMATSU

www.hamamatsu.com

HAMAMATSU PHOTONICS K.K., Solid State Division

1126-1 Ichino-cho, Higashi-ku, Hamamatsu City, 435-8558 Japan, Telephone: (81) 53-434-3311, Fax: (81) 53-434-5184

U.S.A.: Hamamatsu Corporation: 360 Foothill Road, Bridgewater, N.J. 08807, U.S.A., Telephone: (1) 908-231-0960, Fax: (1) 908-231-1218

Germany: Hamamatsu Photonics Deutschland GmbH: Arzbergerstr. 10, D-82211 Herrsching am Ammersee, Germany, Telephone: (49) 8152-375-0, Fax: (49) 8152-265-8

France: Hamamatsu Photonics France S.A.R.L.: 19, Rue du Saule Trapu, Parc du Moulin de Massy, 1882 Massy Cedex, France, Telephone: 33-(1) 69 53 71 00, Fax: 33-(1) 69 53 71 00

United Kingdom: Hamamatsu Photonics UK Limited: 2 Howard Court, 10 Tewin Road, Welwyn Garden City, Hertfordshire AL7 1BW, United Kingdom, Telephone: (44) 1707-294888, Fax: (44) 1707-325777

North Europe: Hamamatsu Photonics Italia S.r.l.: Strada della Moia, 1 int. 6, 20020 Arese (Milano), Italy, Telephone: (39) 02-93581731, Fax: (39) 02-93581741

China: Hamamatsu Photonics (China) Co., Ltd.: B1201, Jiaming Center, No.27 Dongsanhuan Beilu, Chaoyang District, Beijing 100020, China, Telephone: (86) 10-6586-6006, Fax: (86) 10-